TOSHIBA Transistor Silicon PNP Epitaxial Type (PCT process)

2SA1681

Power Amplifier Applications Power Switching Applications

- Low saturation voltage: V_{CE} (sat) = -0.5 V (max) (I_C = -1 A)
- High speed switching time: $t_{stg} = 300 \text{ ns}$ (typ.)
- Small flat package
- $P_C = 1.0$ to 2.0 W (mounted on ceramic substrate)
- Complementary to 2SC4409

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Collector-base voltage	V _{CBO}	-60	V	
Collector-emitter voltage	V _{CEO}	-50	V	
Emitter-base voltage	V _{EBO}	-6	V	
Collector current	Ι _C	-2	А	
Base current	Ι _Β	-0.2	А	
Collector power dissipation	P _C	500	mW	
	P _C	1000		
	(Note)	1000		
Junction temperature	Tj	150	°C	
Storage temperature range	T _{stg}	-55 to 150	°C	

		L	Jnit: mm
$ \begin{array}{c c} 1 \\ \hline 1 \\ \hline 0.45 - 0.05 \\ \hline 0.4 - 0.05 \\ \hline 1.5 \pm 0.1 \\ \hline 1 \\ 1.5 \pm 0.1 \\ \hline 1 \end{array} $	rti th 2 3 use ollector (he	0.8MIN -2.5 ± 0.1 -2.5 ± 0.1	1.6MAX. ± 0.05
PW-MINI			
JEDEC		_	
JEITA	S	C-62	
TOSHIBA	2-	5K1A	

Weight: 0.05 g (typ.)

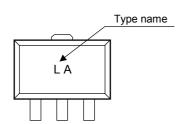
Note: Mounted on ceramic substrate (250 mm² × 0.8 t)



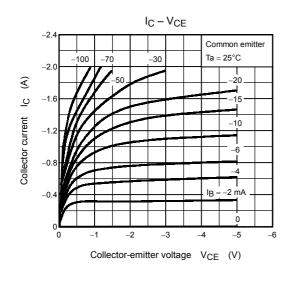
Electrical Characteristics (Ta = 25°C)

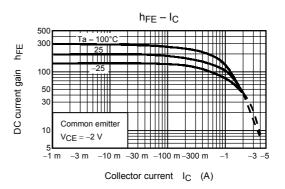
Charac	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off cur	rrent	I _{CBO}	$V_{CB} = -60 \text{ V}, \text{ I}_{E} = 0$	—	_	-0.1	μA
Emitter cut-off current		I _{EBO}	$V_{EB} = -6 V, I_C = 0$	_	_	-0.1	μA
Collector-emitter breakdown voltage		V (BR) CEO	I _C = -10 mA, I _B = 0	-50		_	V
DC aurrent gain	h _{FE (1)}	$V_{CE} = -2 V, I_C = -100 mA$	120	_	400		
DC current gain		h _{FE (2)}	V _{CE} = -2 V, I _C = -1.5 A	40	_	_	
Collector-emitter sa	aturation voltage	V _{CE (sat)}	I _C = 1 A, I _B = -0.05 A	—	_	-0.5	V
Base-emitter saturation voltage		V _{BE (sat)}	I _C = 1 A, I _B = -0.05 A	—	_	-1.2	V
Transition frequency		f _T	$V_{CE} = -2 V, I_C = -100 mA$	_	100	_	MHz
Collector output capacitance		C _{ob}	V _{CB} = -10 V, I _E = 0, f = 1 MHz	_	23	_	pF
Switching time S	Turn-on time	t _{on}	$I_{B1} \bigoplus_{20 \ \mu s} I_{B2} \bigoplus_{I_{B1}} \bigcup_{I_{B1}} \bigcup_{I$	_	0.1	_	
	Storage time	t _{stg}		_	0.3	_	μs
	Fall time	t _f	-I _{B1} = I _{B2} = 0.05 A, DUTY CYCLE ≤ 1%	_	0.1	_	

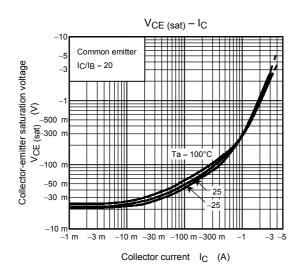
Marking

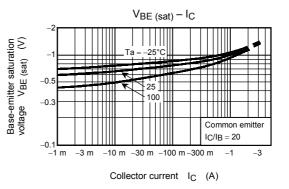


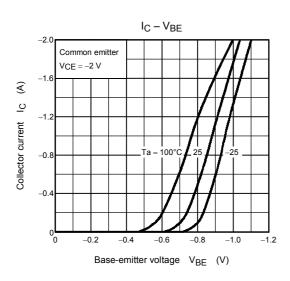
TOSHIBA

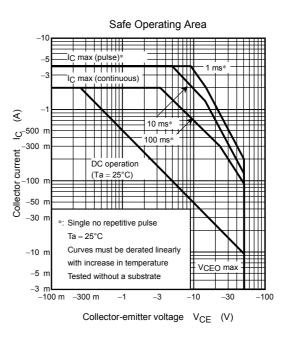












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